

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Group Art Unit: Unknown
Examiner: Unknown

In Re PATENT APPLICATION Of:

Applicants	: CHANG et al.)	
)	
Appln. No.	: Unassigned)	
)	
Filed	: 16 March 2001)	PRELIMINARY
)	<u>AMENDMENT</u>
For	: COAXIAL VIA HOLD AND PROCESS)	
	OF FABRICATING THE SAME)	
)	
Attorney Ref.	: SUND 188)	_____

Commissioner for Patents
Washington, D.C. 20231

Sir:

Preliminary to examination, please amend the application as follows:

IN THE CLAIMS:

27. (Amended) The method of manufacturing a coaxial via hole as claimed in claim 25, wherein in said step (e) making the interior of the second hole become conductive of electricity to form an inner cylinder-shaped conductor includes plating.

28. (Amended) The method of manufacturing a coaxial via hole as claimed in claim 25, wherein in said step (e) making the interior of the second hole become conductive of electricity to form an inner cylinder-shaped conductor includes placing conductive paste in the second hole.

49. (Amended) The method of manufacturing a coaxial via hole as claimed in claim 47, wherein in said step (e), making the interior of the second hole become conductive of electricity to form an inner cylinder-shaped conductor includes plating.


50,(Amended) The method of manufacturing a coaxial via hole as claimed in claim 47, wherein in said step (e), making the interior of the second hole become conductive of electricity to form an inner cylinder-shaped conductor includes placing conductive paste in the second hole.

REMARKS

Please enter these claim changes prior to calculating the fee. Examination of the application is respectfully requested.

Respectfully submitted,

March 16, 2001
Date


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VERSIONS WITH MARKINGS SHOWING CHANGES MADE

27. (Amended) The method of manufacturing a coaxial via hole as claimed in claim 25 [or 26], wherein in said step (e)[,] making the interior of the second hole become conductive of electricity to form an inner cylinder-shaped conductor [by] includes plating.

28. (Amended) The method of manufacturing a coaxial via hole as claimed in claim 25 [or 26], wherein in said step (e)[,] making the interior of the second hole become conductive of electricity to form an inner cylinder-shaped conductor [by] includes placing conductive paste in the second hole.

49. (Amended) The method of manufacturing a coaxial via hole as claimed in claim 47 [or 48], wherein in said step (e), making the interior of the second hole become conductive of electricity to form an inner cylinder-shaped conductor [by] includes plating.

50. (Amended) The method of manufacturing a coaxial via hole as claimed in claim 47 [or 48], wherein in said step (e), making the interior of the second hole become conductive of electricity to form an inner cylinder-shaped conductor [by] includes placing conductive paste in the second hole.